

STP265N6F6AG

Automotive-grade N-channel 60 V, 2.3 mΩ typ., 180 A STripFET™ F6 Power MOSFET in a TO-220 package

Datasheet - production data

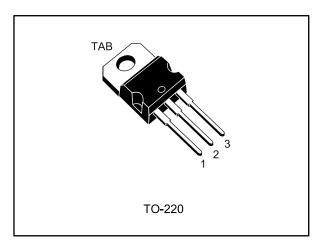
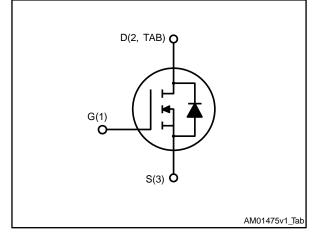


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max	l _D
STP265N6F6AG	60 V	2.85 mΩ	180 A

AEC-Q101 qualified



- Very low on-resistance
- Very low gate charge
- High avalanche ruggedness
- Low gate drive power loss

Applications

• Switching applications

Description

This device is an N-channel Power MOSFET developed using the STripFET $^{\text{TM}}$ F6 technology with a new trench gate structure. The resulting Power MOSFET exhibits very low $R_{\text{DS(on)}}$ in all packages.

Table 1: Device summary

Order code	Marking	Package	Packing
STP265N6F6AG	265N6F6	TO-220	Tube

November 2016 DocID027281 Rev 3 1/13

Contents STP265N6F6AG

Contents

1	Electrical ratings				
2	Electric	cal characteristics	4		
	2.1	Electrical characteristics (curves)	6		
3	Test cir	·cuits	8		
4	Packag	e information	9		
	_	TO-220 mechanical data			
5	Revisio	n history	12		



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STP265N6F6AG Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	60	V
V_{GS}	Gate-source voltage	± 20	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	180	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	180	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	720	Α
Ртот	Total dissipation at T _C = 25 °C	300	W
Eas	Single pulse avalanche energy (Starting T _J = 25 °C, I _D = 80 A) 7		mJ
T _{stg}	Storage temperature range		°C
Tj	Operating junction temperature range	- 55 to 175 °C	

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	0.5	°C/W
R _{thj-amb}	Thermal resistance junction-amb max	62.5	°C/W

⁽¹⁾Current limited by package.

 $[\]ensuremath{^{(2)}}$ Pulse width limited by safe operating area.

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 4: On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 250 μA, V _{GS} = 0 V	60			>
		V _{DS} = 60 V, V _{GS} = 0 V			1	μΑ
I _{DSS}	I _{DSS} Zero gate voltage drain current	$V_{DS} = 60 \text{ V},$ $T_{C} = 125 \text{ °C}^{(1)}$ $V_{GS} = 0 \text{ V}$			100	μΑ
lgss	Gate-body leakage current	$V_{GS} = \pm 20 \text{ V},$ $V_{DS} = 0 \text{ V}$			± 100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2		4	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 60 A		2.3	2.85	mΩ

Notes:

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance	V 25 V	-	11800	ı	pF
Coss	Output capacitance	V _{DS} = 25 V, f = 1 MHz.	-	1235	1	pF
Crss	Reverse transfer capacitance	V _G S = 0 V	-	488	1	pF
Qg	Total gate charge	$V_{DD} = 30 \text{ V},$	-	183	-	nC
Qgs	Gate-source charge	I _D = 120 A,	-	53	-	nC
Qgd	Gate-drain charge	Ves = 10 V (see Figure 14: "Test circuit for gate charge behavior")	-	41	-	nC

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 30 V,	-	31	-	ns
t _r	Rise time	I _D = 60 A	-	165	-	ns
t _{d(off)}	Turn-off-delay time	$R_G = 4.7 \Omega$,	-	144	-	ns
t _f	Fall time	Ves = 10 V (see Figure 13: "Test circuit for resistive load switching times" and Figure 18: "Switching time waveform")	-	63	ı	ns

DocID027281 Rev 3

 $[\]ensuremath{^{(1)}}\mbox{Defined}$ by design, not subject to production test.

Table 7: Source drain diode

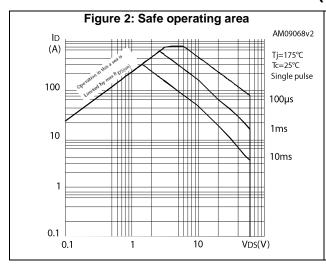
Table 7. Source drain diode						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isp	Source-drain current				180	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				720	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 180 A, V _{GS} = 0 V			1.1	V
t _{rr}	Reverse recovery time	Isp = 120 A,	-	56	-	ns
Qrr	Reverse recovery charge	V _{DD} = 48 V	-	116	-	nC
IRRM	Reverse recovery current	di/dt = 100 A/μs, T _j = 150 °C (see Figure 15: "Test circuit for inductive load switching and diode recovery times")	-	3.8	-	А

Notes:

⁽¹⁾ Pulse width limited by safe operating area.

 $^{^{(2)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s,}$ duty cycle 1.5%

2.1 Electrical characteristics (curves)



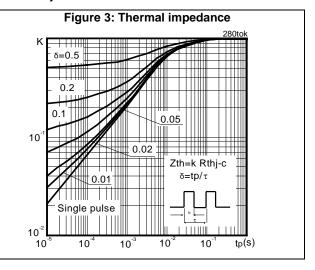
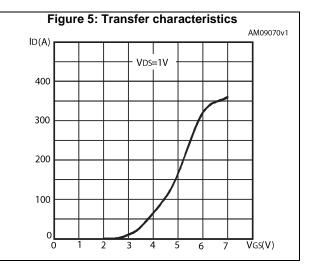
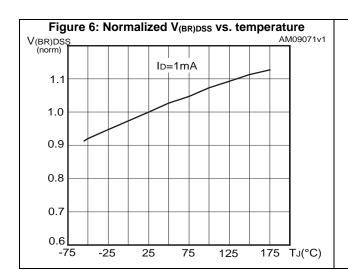
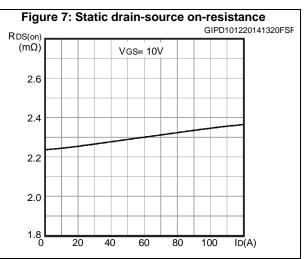


Figure 4: Output characteristics AM09069v1 ID(A) 400 VGS=10V 350 6V 300 250 5V 200 150 100 50 0 2 3 VDS(V)



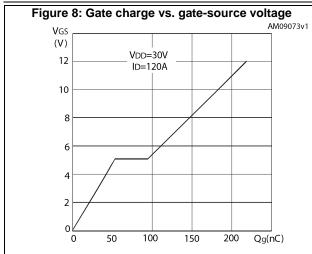




DocID027281 Rev 3

6/13

STP265N6F6AG Electrical characteristics



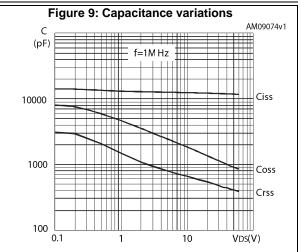
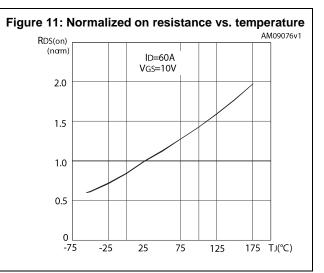
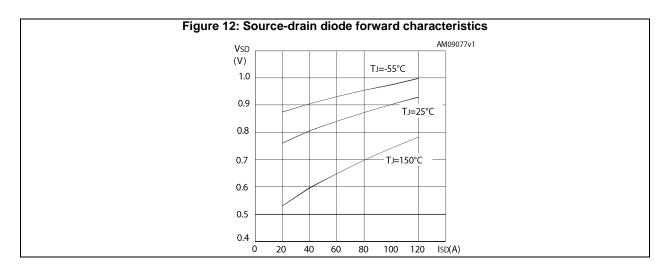


Figure 10: Normalized gate threshold voltage vs. temperature AM09075v1 VGS(th) (nam) 1.2 ID=250μA 1.0 0.8 0.6 0.4 0.2 -75 -25 25 75 125 175 TJ(°C)





Test circuits STP265N6F6AG

3 Test circuits

Figure 13: Test circuit for resistive load switching times

Figure 14: Test circuit for gate charge behavior

12 V 47 KΩ 100 Ω D.U.T.

12 V 47 KΩ VGD

14 VGD

15 VGD

16 CONST 100 Ω D.U.T.

17 VGD

18 VGD

18 VGD

18 VGD

18 VGD

19 VGD

18 VGD

19 VGD

10 VGD

10 VGD

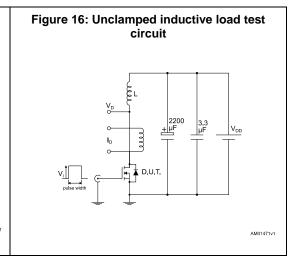
11 KΩ

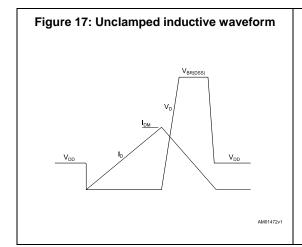
AM01469v1

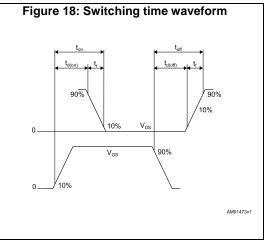
Figure 15: Test circuit for inductive load switching and diode recovery times

AMD14

Figure 15: Test circuit for inductive load switching and diode recovery times







577

8/13 DocID027281 Rev 3

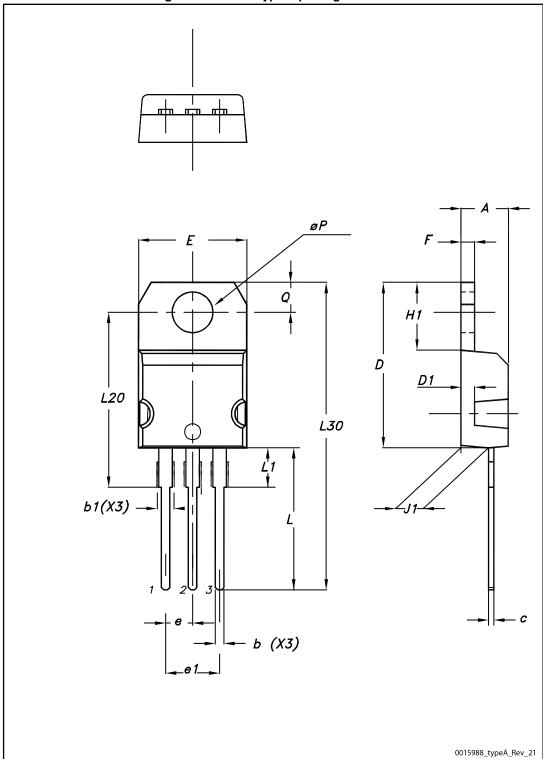
4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



4.1 TO-220 mechanical data

Figure 19: TO-220 type A package outline



577

Table 8: TO-220 type A mechanical data

Tuble C. 10 220 type // meenamear adia				
Dim.		mm		
Dilli.	Min.	Тур.	Max.	
Α	4.40		4.60	
b	0.61		0.88	
b1	1.14		1.55	
С	0.48		0.70	
D	15.25		15.75	
D1		1.27		
E	10.00		10.40	
е	2.40		2.70	
e1	4.95		5.15	
F	1.23		1.32	
H1	6.20		6.60	
J1	2.40		2.72	
L	13.00		14.00	
L1	3.50		3.93	
L20		16.40		
L30		28.90		
øΡ	3.75		3.85	
Q	2.65		2.95	

Revision history STP265N6F6AG

5 Revision history

Table 9: Document revision history

Date	Revision	Changes
10-Dec-2014	1	First release.
16-Dec-2014	2	Document status promoted from preliminary to production data.
		The part number STW265N6F6AG has been moved to a separate datasheet.
16-Nov-2016	3	Updated title, cover image, features and description in cover page. Updated Table 1: "Device summary", Table 3: "Thermal data", Section 4: "Package information".
		Minor text changes.

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